19.1 Introduction

Today, our society has become very aware of the necessity of the natural environment protection of our living plant in the face of a programmed utilization of natural resource. Like the earth, the utility power supply that we are now using was clean when it was invented in nineteenth century. Over hundred years, electrical power system has benefited people in every aspect. Meanwhile, due to the intensive use of this utility, the power supply condition becomes “polluted.” However, public concern about the “dirty” environment in the power system has not been drawn until the mid 1980s [1–6].

Since ac electrical energy is the most convenient form of energy to be generated, transmitted, and distributed, ac power systems had been swiftly introduced into industries and residences since the turn of the twentieth century. With the proliferation of utilization of electrical energy, more and more heavy loads have been connected into the power system. During 1960s, large electricity consumers such as electrochemical and electrometallurgical industries applied capacitors as VAR compensator to their systems to minimize the demanded charges from utility companies and to stabilize the supply voltages. As these capacitors present low impedance in the system, harmonic currents are drawn from the line. Owing to the non-zero system impedance, line voltage distortion will be incurred and propagated. The contaminative harmonics can decline power quality and affect the system performance in several ways:

(a) The line rms current harmonics do not deliver any real power in Watts to the load, resulting in inefficient use of equipment capacity (i.e. low power factor).
(b) Harmonics will increase conductor loss and iron loss in transformers, decreasing transmission efficiency and causing thermal problems.
(c) The odd harmonics are extremely harmful to a three-phase system, causing overload of the unprotected neutral conductor.
(d) Oscillation in power system should be absolutely prevented in order to avoid endangering the stability of system operation.
(e) High peak harmonic currents may cause automatic relay protection devices to mistrigger.
(f) Harmonics could cause other problems such as electromagnetic interference to interrupt communication, degrading reliability of electrical equipment, increasing product defective ratio, insulation failure, audible noise, etc.

Perhaps the greatest impact of harmonic pollution appeared in early 1970s when static VAR compensators (SVCs) were extensively used for electric arc furnaces, metal rolling mills, and other high power appliances. The harmonic currents
produced by partial conduction of SVC are odd order, which are especially harmful to three-phase power system. Harmonics can affect operations of other devices that are connected to the same system and, in some situation, the operations of themselves that generate the harmonics.

The ever deteriorated supply environment did not become a major concern until the early 1980s when the first technical standard IEEE519-1981 with respect to harmonic control at point of common coupling (PCC) was issued [7]. The significance of issuing this standard was not only that it provided the technical reference for design engineers and manufactures, but also that it opened the door of research area of harmonic reduction and power factor correction (PFC). Stimulated by the harmonic control regulation, researchers and industry users started to develop low-cost devices and power electronic systems to reduce harmonics since it is neither economical nor necessary to eliminate the harmonics.

Research on harmonic reduction and PFC has become intensified in the early nineties. With the rapid development in power semiconductor devices, power electronic systems have matured and expanded to new and wide application range from residential, commercial, aerospace to military and others. Power electronic interfaces, such as switch mode power supplies (SMPS), are now clearly superior over the traditional linear power supplies, resulting in more and more interfaces switched into power systems. While the SMPSs are highly efficient, but because of their non-linear behavior, they draw distorted current from the line, resulting in high total harmonic distortion (THD) and low power factor (PF).

To achieve a smaller output voltage ripple, practical SMPSs use total harmonic distortion (THD) and low power factor (PF). They draw distorted current from the line, resulting in high power electronic systems. In a linear system, because load draws purely sinusoidal current and voltage, the PF is only determined by the phase difference between \( v(t) \) and \( i(t) \). Equation (19.1) becomes

\[
PF = \frac{I_{rms}V_{rms}}{I_{rms}V_{rms}} \cos \theta = \cos \theta \tag{19.2}
\]

where, \( I_{rms} \) and \( V_{rms} \) are rms values of line current and line voltage, respectively, and \( \theta \) is the phase shift between line current and line voltage. Hence, in linear power systems, the PF is simply equal to the cosine of the phase angle between the current and voltage. However, in power electronic system, due to the non-linear behavior of active switching power devices, the phase-angle representation alone is not valid. Figure 19.1b shows that the non-linear load draws typical distorted line current from the line. Calculating PF for distorted waveforms is more complex when compared with the sinusoidal case. If both line voltage and line current are distorted, then
Eqs. (19.3) and (19.4) give the Fourier expansion representations for the line current and line voltage, respectively

\[ i(t) = I_{DC} + I_{1} \sin(\omega t + \theta_{1}) + \sum_{n=2}^{\infty} I_{n} \sin(n \omega t + \theta_{n}) \]  (19.3)

\[ v(t) = V_{DC} + V_{1} \sin(\omega t + \theta_{1}) + \sum_{n=2}^{\infty} V_{n} \sin(n \omega t + \theta_{n}) \]  (19.4)

Applying the definition of PF given in Eq. (19.1) to the distorted current and voltage waveforms of Eqs. (19.3) and (19.4), PF may be expressed as

\[ PF = \frac{I_{1,\text{rms}} \cos \theta_{1}}{I_{\text{rms}}} = k_{\text{dist}} \cdot k_{\text{disp}} \]  (19.8)

where,

- \( \theta_{1} \): the phase angle between the voltage \( v(t) \) and the fundamental component of \( i(t) \);
- \( I_{1,\text{rms}} \): rms value of the fundamental component in line current;
- \( I_{\text{rms}} \): total rms value of line current;
- \( k_{\text{dist}} \): distortion factor;
- \( k_{\text{disp}} \): displacement factor.

Another important parameter that measures the percentage of distortion is known as the current total harmonic distortion (THDi) which is defined as follows

\[ THDi = \sqrt{\sum_{n=2}^{\infty} \frac{I_{n,\text{rms}}^{2}}{I_{1,\text{rms}}^{2}}} = \sqrt{\frac{1}{k_{\text{dist}}} - 1} \]  (19.9)

Conventionally SMPSs use capacitive rectifiers in front of the ac line which results in the capacitor voltage \( v_{C}(t) \) and high rms pulsating line current \( i_{L}(t) \) as shown in Fig. 19.2, when \( v(t) \) is the line voltage. As a result, THDi is as high as 70% and poor PF is usually less than 0.67.
As we can see from Eqs. (19.8) and (19.9), PF and THD are related to distortion and displacement factors. Therefore, improvement in PF, i.e. power factor correction (PFC), also implies harmonic reduction.

19.3 Power Factor Correction

19.3.1 Energy Balance in PFC Circuits

Figure 19.3 shows a diagram of an ac–dc PFC unit. Let \( v_l(t) \) and \( i_l(t) \) be the line voltage and line current, respectively. For an ideal PFC unit (PF = 1), we assume

\[
\begin{align*}
  v_l(t) &= V_{lm} \sin \omega_l t \\
  i_l(t) &= I_{lm} \sin \omega_l t
\end{align*}
\]

(19.10a)

(19.10b)

where, \( V_{lm} \) and \( I_{lm} \) are amplitudes of line voltage and line current, respectively, and \( \omega_l \) is the angular line frequency.

The instantaneous input power is given by

\[ p_{in}(t) = V_{lm} I_{lm} \sin^2 \omega_l t = P_{in} (1 - \cos 2\omega_l t) \]  

(19.11)

where, \( P_{in} = 1/2 V_{lm} I_{lm} \) is the average input power.

As we can see from Eq. (19.11), the instantaneous input power contains not only the real power (average power) \( P_{in} \) component but also an alternative component with frequency \( 2\omega_l \) (i.e. 100 or 120 Hz), shown in Fig. 19.4. Therefore, the operation principle of a PFC circuit is to process the input power in a certain way that it stores the excessive input energy (area I in Fig. 19.4) when \( p_{in}(t) \) is larger than \( P_{in}(=P_o) \), and releases the stored energy when \( p_{in}(t) \) is less than \( P_{in}(=P_o) \) to compensate for area II.

The instantaneous excessive input energy, \( w(t) \), is given by

\[ w_{ex}(t) = \frac{P_o}{2\omega_l} (1 - \sin 2\omega_l t) \]  

(19.12)

At \( t = 3T_l/8 \), the excessive input energy reaches the peak value

\[ w_{ex,max} = \frac{P_o}{\omega_l} \]  

(19.13)

The excessive input energy has to be stored in the dynamic components (inductor and capacitor) in the PFC circuit.
In most of the PFC circuits, an input inductor is used to carry the line current. For unity PF, the inductor current (or averaged inductor current in switch mode PFC circuit) must be a pure sinusoidal and in phase with the line voltage. The energy stored in the inductor \( \frac{1}{2} L_i^2(t) \) cannot completely match the change of the excessive energy as shown in Fig. 19.4. Therefore, to maintain the output power constant, another energy storage component (usually the output capacitor) is needed.

**19.3.2 Passive Power Factor Corrector**

Because of their high reliability and high power handling capability, passive power factor correctors are normally used in high power line applications. Series tuned LC harmonic filter is commonly used for heavy plant loads such as arc furnaces, metal rolling mills, electrical locomotives, etc. Figure 19.5 shows a connection diagram of harmonic filter together with line frequency switched reactor static VAR compensator. By tuning the filter branches to odd harmonic frequencies, the filter shunts the harmonic currents. Since each branch presents capacitive at line frequency, the filter also provides capacitive VAR for the system. The thyristor-controlled reactor keeps an optimized VAR compensation for the system so that higher PF can be maintained.

The design of the tuned filter PF corrector is particularly difficult because of the uncertainty of the system impedance and harmonic sources. Besides, this method involves too many expensive components and takes huge space.

For the applications where power level is less than 10 kW, the tuned filter PF corrector may not be a better choice. The most common off-line passive PF corrector is the inductive-input filter, shown in Fig. 19.6. Depending on the filter inductance, this circuit can give a maximum of 90% PF. For operation in continuous conduction mode (CCM), the PF is defined as [11]

\[
PF = \frac{0.9}{\sqrt{1 + (0.075/K_1)^2}}
\]  

(19.14)

Where

\[
K_1 = \frac{\omega L}{\pi R}
\]  

(19.15)

The PF corrector is simply a low pass inductive filter as shown in Fig. 19.7, whose transfer function and input impedance are given by

\[
H(s) = \frac{1}{\sqrt{sLC + sLR + 1}}
\]  

(19.16)

\[
Z_{in}(s) = \frac{R^2 s^2LC + sL/R + 1}{sRC + 1}
\]  

(19.17)

The above equations show that the unavoidable phase displacement is incurred in the inductive-filter corrector. Because the filter frequency of operation is low (line frequency), large value inductor and capacitor have to be used. As a result, the following disadvantages are presented in most passive PF correctors:

(a) Only less than 0.9 PF can be achieved;

(b) THD is high;

(c) They are heavy and bulky;

(d) The output is unregulated;

(e) The dynamic response is poor;

(f) They are sensitive to circuit parameters;

(g) Optimization of the design is difficult.

![FIGURE 19.5 Series tuned LC harmonic filter PF corrector.](image1)

![FIGURE 19.6 Inductive-input PF corrector.](image2)

![FIGURE 19.7 Low pass inductive filter.](image3)
19.3.3 Basic Circuit Topologies of Active Power Factor Correctors

In recent years, using the switched-mode topologies, many circuits and control methods are developed to comply with certain standard (such as IEEE Std 519 and IEC1000-3-2). To achieve this, high-frequency switching techniques have been used to shape the input current waveform successfully. Basically, the active PF correctors employ the six basic converter topologies or their variation versions to accomplish PFC.

A. The Buck Corrector

Figure 19.8a shows the buck PF corrector. By using PWM switch modeling technique [12], the circuit topology can be modeled by the equivalent circuit shown in Fig. 19.8b. It should be pointed out that the circuit model is a large signal model, therefore analysis of PF performance based on this model is valid. It can be shown that the transfer function and input impedance are given by

\[ H(s) = \frac{d}{s^2LC + sL/R + 1} \]  \hspace{1cm} (19.18)  

\[ Z_{in}(s) = \frac{Rd^2}{s^2LC + sL/R + 1} + \frac{1}{sRC + 1} \]  \hspace{1cm} (19.19)

where \( d \) is the duty ratio of the switching signal.

Notice that Eqs. (19.18) and (19.19) are different from Eqs. (19.16) and (19.17), in that they have introduced the control variable \( d \). By properly controlling the switching duty ratio to modulate the input impedance and the transfer function, a pure resistive input impedance and constant output voltage can be approached. Thereby, unity PF and output regulation can both be achieved. These control techniques will be discussed in the next section.

Comparing with the other type of high frequency PFC circuits, the buck corrector offers inrush-current limiting, overload or short-circuit protection, and over-voltage protection for the converter due to the existence of the power switch in front of the line. Another advantage is that the output voltage is lower than the peak of the line voltage, which is usually the case normally desired. The drawbacks of using buck corrector may be summarized as follows:

(a) When the output voltage is higher than the line voltage, the converter draws no current from the line, resulting in significant line current distortion near the zero-across of the line voltage;
(b) The input current is discontinuous, leading to high differential mode EMI;
(c) The current stress on the power switch is high;
(d) The power switch needs a floating drive.

B. The Boost Corrector

The boost corrector and its equivalent PWM switch modeling circuit are shown in Figs. 19.9a and b. Its transfer function and

\[ \text{FIGURE 19.8} \hspace{1cm} (a) \text{ Buck corrector and (b) PWM switch model for buck corrector.} \]

\[ \text{FIGURE 19.9} \hspace{1cm} (a) \text{ Boost corrector and (b) PWM switch model of boost corrector.} \]
input impedance are given by

\[
H(s) = \frac{1/d'}{s^2(L/d'^2)C + s(L/d'^2)/R + 1}
\]  \hspace{1cm} (19.20)

\[
Z_{in}(s) = d'^2R s^2\left(\frac{L/d'^2}{C} + s(L/d'^2)/R + 1\right) / sRC + 1
\]  \hspace{1cm} (19.21)

where \( d' = 1 - d \).

Unlike in the buck case, it is interesting to note that in the boost case, the equivalent inductance is controlled by the switching duty ratio. Consequently, both the magnitude and the phase of the impedance, and both the dc gain and the pools of the transfer function are modulated by the duty ratio, which implies a tight control of the input current and the output voltage. Other advantages of boost corrector include less EMI and lower switch current and grounded drive. The shortcomings with the boost corrector are summarized as:

(a) The output voltage must be higher than the peak of line voltage;
(b) Inrush-current limiting, overload, and over-voltage protections are not available.

C. The Buck–Boost Corrector

The buck–boost corrector and its equivalent circuit are shown in Figs. 19.10a and b. The expressions for transfer function and input impedance are

\[
H(s) = \frac{d/d'}{s^2(L/d'^2)C + s(L/d'^2)/R + 1}
\]  \hspace{1cm} (19.22)

\[
Z_{in}(s) = \left(\frac{d'}{d}\right)^2 R s^2\left(\frac{L/d'^2}{C} + s(L/d'^2)/R + 1\right) / sRC + 1
\]  \hspace{1cm} (19.23)

The buck–boost corrector combines some advantages of the buck corrector and the boost corrector. Like a buck corrector, it can provide circuit protections and step-down output voltage, and like a boost corrector its input current waveform and output voltage can be tightly controlled. However, the buck–boost corrector has the following disadvantages:

(a) The input current is discontinued by the power switch, resulting in high differential mode EMI;
(b) The current stress on the power switch is high;
(c) The power switch needs a floating drive;
(d) The polarity of output voltage is reversed.

D. The Cuk, Sepic, and Zeta Correctors

Unlike the previous converters, the Cuk, Sepic, and Zeta converters are fourth-order switching-mode circuits. Their circuit topologies for PFC are shown in Figs. 19.11a, b, and c, respectively. Because there are four energy storage components available to handle the energy balancing involved in PFC, second harmonic output voltage ripples of these correctors are smaller when compared with the second-order buck, boost, and buck–boost topologies. These PF correctors are also able to provide overload protection. However, the increased count of components and current stress are undesired.

19.3.4 System Configurations of PFC Power Supply

The most common configurations of ac–dc power supply with PFC are two-stage scheme and one-stage (or single-stage) scheme. In two-stage scheme as shown in Fig. 19.12a, a non-isolated PFC ac–dc converter is connected to the line to create an intermediate dc bus. This dc bus voltage is usually full of second harmonic ripple. Therefore, followed by the ac–dc converter, a dc–dc converter is cascaded to provide electrical isolation and tight voltage regulation. The advantage of two-stage structure gives two power stages can be controlled separately, and thus it makes it possible to have both converters optimized. The drawbacks of this scheme are lower efficiency due to twice processing of the input power, complex control circuits, higher cost, and low reliability. Although the two-stage scheme approach is commonly adopted in industry, it received limited attention by the common research, since the input stage and output stage can be studied independently. One-stage scheme combines the PFC circuit and power conversion circuit in one stage as shown in Fig. 19.12b. Due to its
simplified structure, this scheme is potentially more efficient and is very attractive in low to medium power level applications, particularly in those cost-sensitive applications. The one-stage scheme, therefore becomes the main stream of contemporary research due to the ever-increasing demands for inexpensive power supply in residential and office appliance.

For many single-stage PFC converters, one of the most important issues is the slow dynamic response under line and load changes. To remove the low frequency ripple caused by the line (120 Hz) from the output and keep a nearly constant operation duty ratio, a large volume output capacitor is normally used. Consequently, a low frequency pole (typically less than 20 Hz) must be introduced into the feedback loop. This results in very slow dynamic response of the system [13, 14].

To avoid twice power process in two-stage scheme, two converters can be connected in parallel to form so-called parallel PFC scheme [15]. In parallel PFC circuit, power from the ac main to the load flows through two parallel paths, shown in Fig. 19.12c. The main path is a rectifier, in which power is not processed twice for PFC, whereas the other path processes the input power twice for PFC purpose. It is shown that to achieve both unity PF and tight output voltage regulation, only the difference between the input and output power within a half cycle (about 32% of the average input power) needs to be processed twice [15]. Therefore, high efficiency can be obtained by this method.

The continuous research in improving system PF has resulted in countless circuit topologies and control strategies. Classified by their principles to realize PFC, they can be mainly categorized into discontinuous conduction mode (DCM) input technique and continuous conduction mode (CCM) shaping technique. The recent research interest in DCM input technique is focused on developing PFC circuit topologies with a single power switch, result in single-stage single-switch converter (so-called $S^4$-converter). The CCM shaping technique emphasizes on the control strategy to
achieve unity input PF. The hot topics in this line of research are concentrated on degrading complexity of the control circuit and enhancing dynamic response of the system, resulting in some new control methods. Figure 19.13 shows an overview of these techniques based on conduction mode and system configuration types.

### 19.4 CCM Shaping Technique

Like other power electronic apparatus, the core of a PFC unit is its converter, which can operate either in DCM or in CCM. As shall be discussed in the next section, the benefit from DCM technique is that low-cost power supply can be achieved because of its simplified control circuit. However, the peak input current of a DCM converter is at least twice as high as its corresponding average input current, which causes higher current stresses on switches than that in a CCM converter, resulting in intolerable conduction and switching losses as well as transformer copper losses in high power applications. In practice, DCM technique is only suitable for low to medium level power application, whereas, CCM is used in high power cases. However, a converter operating in CCM does not have PFC ability inherently, i.e. unless a certain control strategy is applied, the input current will not follow the waveform of line voltage. This is why most of the research activities in improving PF under CCM condition have been focused on developing new current shaping control strategies. Depending on the system variable being controlled (either current or voltage), PFC control techniques may be classified as current control and voltage control. Current control is the most common control strategy since the primary objective of PFC is to force the input current to trace the shape of line voltage.

To achieve both PFC and output voltage regulation by using a converter operating in CCM, multiloop controls are generally used. Figure 19.14 shows the block diagram of a–d PFC converter with CCM shaping technique, where, \( H_1 \) is a line voltage compensator, \( H_x \) is a controlled variable compensator, and \( x(t) \) is the control variable that can be either current or voltage.

Normally, in order to obtain a sinusoidal line current and a constant dc output voltage, line voltage \( v_l(t) \), output voltage \( V_o \), and a controlled variable \( x(t) \) need to be sensed. Depending on whether the controlled variable \( x(t) \) is a current (usually the line current or the switch current) or a voltage (related to the line current), the control technique is called “current mode control” or “voltage mode control,” respectively. In Fig. 19.14, two control loops have been applied: the feedforward loop and the feedback loops. The feedforward loop is also called “inner loop” which keeps the line current to follow the line voltage in shape and phase, while the feedback loop (also called “outer loop”) keeps the output voltage to be tightly controlled. These two loops share the same control command generated by the product of output voltage error signal and the line voltage (or rectified line voltage) signal.
19.4.1 Current Mode Control

Over many years, different current mode control techniques were developed. In this section, we will review several known methods.

A. Average Current Control

In average current control strategy, the average line current of the converter is controlled. It is more desired than the other control strategies because the line current in a SMPS can be approximated by the average current (per switching cycle) through an input EMI filter. The average current control is widely used in industries since it offers improved noise immunity, lower input ripple, and stable operation [13, 16–19].

Figure 19.15 shows a boost PFC circuit using average current control strategy. In the feedforward loop, a low value resistor $R_s$ is used to sense the line current. Through the op-amp network formed by $R_i$, $R_{imo}$, $R_f$, $C_p$, $C_z$, and $A_2$, average line current is detected and compared with the command current signal, $i_{cmd}$, which is generated by the product of line voltage signal and the output voltage error signal.

There is a common issue in CCM shaping technique, i.e. when the line voltage increases, the line voltage sensor provides an increased sinusoidal reference for the feedforward loop. Since the response of feedback loop is much slower than the feedforward loop, both the line voltage and the line current increase, i.e. the line current is heading to wrong changing direction (with the line voltage increasing, the line current should decrease). This results in excessive input power, causing overshoot in the output voltage. The square block, $x^2$, in the line voltage-sensing loop shown in Fig. 19.15 provides a typical solution for this problem. It squares the output of the low-pass filter (LPF), which is in proportion to the amplitude of the line voltage, and provides the divider $(A + B)/C$ with a squared line voltage signal for its denominator. As a result, the amplitude of the sinusoidal reference $i_{cmd}$ is negatively proportional to the line voltage, i.e. when the line voltage changes, the control circuit leads the line current to change in the opposite direction, which is the desired situation. The detailed analysis and design issues can be found in [16–18].

As it can be seen, the average current control is a very complicated control strategy. It requires sensing the inductor current, the input voltage, and the output voltage. An amplifier for calculating the average current and a multiplier are needed. However, because of today’s advances made in IC technology, these circuits can be integrated in a single chip.

B. Variable Frequency Peak Current Control

Although the average current control is a more desired strategy, the peak current control has been widely accepted because it improves the converter efficiency and has a simpler control circuit [14, 20–24]. In variable frequency peak control strategy, shown in Fig. 19.16, the output error signal $k(t)$ is fed
back through its outer loop. This signal is multiplied by the line voltage signal $\alpha v_1(t)$ to form a line current command signal $i_{cmd}(t) = \alpha v_1(t)$, The command signal $i_{cmd}(t)$ is the desired line current shape since it follows the shape of the line voltage. The actual line current is sensed by a transducer, resulting in signal $\beta i_1(t)$ by feeding it back through the inner loop. After comparing the line current signal $\beta i_1(t)$ with the command signal $i_{cmd}(t)$, the following control strategies can be realized, depending on its logic circuit:

**Constant on-time control:** Its input current waveform is given in Fig. 19.17a. Letting the fixed on-time to be $T_o$, the control rules are:
- At $t = t_k$ when $\beta i_1(t_k) = i_{cmd}(t_k)$, S is turned on;
- At $t = t_k + T_o$, S is turned off.

**Constant off-time control:** The input current waveform is shown in Fig. 19.17b. Assuming the off-time is $T_{off}$, the control rules are:
- At $t = t_k$ when $\beta i_1(t_k) = i_{cmd}(t_k)$, S is turned off;
- At $t = t_k + T_{off}$, S is turned on.

**C. Constant Frequency Peak Current Control**

Generally speaking, to make it easier to design the EMI filter and to reduce harmonics, constant switching frequency ac–dc PFC converter is preferred. Based on the block diagram shown in Fig. 19.18, with $T_s$ is the switching period, the following control rules can be considered to realize a constant frequency peak current control (shown in Fig. 19.19b):
- At $t = nT_s$, S is turned on;
- At $t = t_o$ when $\beta i_1(t_o) = i_{cmd}(t_o)$, S is turned off.

**FIGURE 19.17** Input current waveforms for variable frequency peak current control: (a) constant on-time control and (b) constant off-time control.

**FIGURE 19.18** Logic circuit for constant frequency peak current control.

**FIGURE 19.19** (a) Constant frequency peak current control with stabilizing ramp compensation and (b) line current waveform for constant frequency peak current control.
The logic circuit for the above control rules can be realized by using an R–S flip-flop with a constant frequency setting clock pulse (CP), as shown in Fig. 19.18. Unfortunately, this logic circuit will result in instability when the duty ratio exceeds 50%. This problem can be solved by subtracting a stabilizing ramp signal from the original command signal. Figure 19.19a shows a complete block diagram for typical constant frequency peak current control strategy. The line current waveform is shown in Fig. 19.19b.

It should be noticed that in both variable frequency and constant frequency peak current control strategies, either the input current or the switch current could be controlled. Thus it makes possible to apply these control methods to buck type converters. There are several advantages of using peak current control:

- The peak current can be sensed by current transformer, resulting in reduced transducer loss;
- The current-error compensator for average control method has been eliminated;
- Low gain in the feedforward loop enhances the system stability;
- The instantaneous pulse-by-pulse current limit leads to increased reliability and response speed.

However the three signals, line voltage, peak current, and output voltage signals, are still necessary to be sensed and multiplier is still needed in each of the peak current control method. Comparing with the average current control methods, the hysteresis control method has simpler implementation and increased reliability and response speed.

D. Hysteresis Control

Unlike the constant on-time and the constant off-time control, in which only one current command is used to limit either the minimum input current or the maximum input current, the hysteresis control has two current commands, \(i_{\text{cmd}}(t)\) and \(i_{\text{hcmd}}(t)\) (\(i_{\text{cmd}}(t) = \delta i_{\text{cmd}}(t)\)), to limit both the minimum and the maximum of input current [25–28]. To achieve smaller ripple in the input current, we desire a narrow hysteresis band. However, the narrower the hysteresis band, the higher the switching frequency. Therefore, the hysteresis band should be optimized based on circuit components such as switching devices and magnetic components. Moreover, the switching frequency varies with the change of line voltage, resulting in difficulty in the design of the EMI filter. The circuit diagram and input current waveform are given in Figs. 19.20a and b, respectively. When \(\beta i(t) \geq i_{\text{cmd}}(t)\), a negative pulse is generated by comparator A1 to set the R–S flip-flop. The control rules are:

- At \(t = t_k\) when \(\beta i(t_k) = i_{\text{cmd}}(t)\), S is turned on;
- At \(t = t_{k+1}\) \(\beta i(t_{k+1}) = i_{\text{hcmd}}(t)\), S is turned off;
- When \(\beta i(t) = i_{\text{cmd}}(t) = i_{\text{hcmd}}(t)\), S stays on or off.

Like the above mentioned peak current control methods, the hysteresis control method has simpler implementation, enhanced system stability, and increased reliability and response speed. In addition, it has better control accuracy than that the peak current control methods have. However, this improvement is achieved on the penalty of wide range of variation in the switching frequency. It is also possible to improve the hysteresis control in a constant frequency operation [29, 30], but usually this will increase the complexity of the control circuit.

E. Charge Control

In order to make the average control method to be applicable for buck-derived topologies where the switch current instead
of the inductor current needs to be controlled, an alternative method to realize average current control, namely, charge control was proposed in [31–33]. Since the total charge of the switch current per switching cycle is proportional to the average value of the switch current, the average current can be detected by a capacitor-switch network. Figure 19.21 shows a block diagram for charge control. The switch current is sensed by current transformer T1 and charges the capacitor C_T to form average line current signal. As the switch current increases, the charge on capacitor C_T also increases. When the voltage reaches the control command v_c, the power switch turns off. At the same time, the switch S_d turns on to reset the capacitor. The next switching cycle begins with the power switch turning on and the switch S_d turning off by a clock pulse.

The advantages of charge control are:

- Ability to control average switch current;
- Better switching noise immunity than peak current control;
- Good dynamic performance;
- Elimination of turn off failure in some converters (e.g. multiresonant converter) when the switch current reaches its maximum value.

The disadvantages are:

- Synthesis of the reference v_c still requires sensing both input and output voltage and use of a multiplier;
- Subharmonic oscillation may exist.

F. Non-linear-carrier (NLC) Control

To further simplify the control circuitry, non-linear-carrier control methods were introduced [34, 35]. In CCM operation, since the input voltage is related to the output voltage through the conversion ratio, the input voltage information can be recovered by the sensed output voltage signal. Thus the sensing of input voltage can be avoided, and therefore, the multiplier is not needed, resulting in significant simplification in the control circuitry. However, complicated NLC waveform generator and its designs are involved. Figure 19.22 shows the block diagram of the NLC charge control first introduced in [34].

19.4.2 Voltage Mode Control

Generally, current mode control is preferred in current source driven converters, as the boost converter. To develop controllers for voltage source driven converter, like the buck converter and to improve dynamic response, voltage mode control strategy was proposed [36, 37]. Figure 19.23 shows the
input circuit of an ac–dc converter and its phasor diagram representation, where $\phi$ is the phase shift between the line current and the capacitor voltage. An LC network could be added to the input either before a switch mode rectifier (SMR) or after a passive rectifier to perform such kind of control. In boost type converter, the inductor $L_i$ is the input inductor. It can be seen from the phasor diagram that to keep the line current in phase with the line voltage, we can either control the capacitor voltage or the inductor voltage. If the capacitor voltage is chosen as controlled variable, the control strategy is known as delta modulation control.

A. Capacitor Voltage Control

Figure 19.24 gives a SMR with PFC using capacitor voltage control [36]. The capacitor voltage $v_{C1}(t)$ is forced to track a sinusoidal command $v^*_C(t)$ signal to indirectly adjust the line current in phase with the line voltage. The command signal is the product of the line voltage signal with a phase shift of $\phi$ and the feedback error signal. The phase shift $\phi$ is a function of the magnitudes of line voltage and line current, therefore the realization of a delta control is not really simple. In addition, since $\phi$ is usually very small, a small change in capacitor voltage will cause a large change in the inductor voltage, and hence in the line current. Thus it makes the circuit very sensitive to parameter variations and perturbations.

B. Inductor Voltage Control

To overcome the above shortcomings, inductor voltage control strategies was reported in [37]. Figure 19.25 shows an SMR with PFC using inductor voltage control. As the phase difference between the line voltage and the inductor voltage is fixed at $90^\circ$ ideally, the control circuit is simpler in implementation than that of capacitor voltage control. As the inductor voltage is sensitive to the phase shift $\phi$, but not sensitive to the change in magnitude of reference, the inductor voltage control method is more effective in keeping the line current in phase with the line voltage. However, in the implementations of both the two kinds of voltage control methods hysteresis technique is normally used. Therefore, unlike the previous current mode control, variable frequency problem is encountered in these control methods.

Generally speaking, by using CCM shaping technique, the input current can trace the wave shape of the line voltage well. Hence the PF can be improved efficiently. However, this technique involves in the designing of complicated control circuits. Multiloop control strategy is needed to perform input current shaping and output regulation. In most CCM shaping techniques, current sensor, and multiplier are required, which results in higher cost in practical applications. In some cases, variable frequency control is inevitable, resulting in additional difficulties in its closedloop design. Table 19.1 gives a comparison among these control methods.

19.5 DCM Input Technique

To get rid of the complicated control circuit invoked by CCM shaping technique and reduce the cost of the electronic interface, DCM input technique can be adopted in low power to medium power level application.

In DCM, the inductor current of the core converter is no longer a valid state variable since its state in a given switching cycle is independent of the value in the previous switching cycle [38]. The peak of the inductor current is sampling the line voltage automatically, resulting in sinusoidal-like average input current (line current). This is why DCM input circuit is also called “voltage follower” or “automatic controller.” The benefit of using DCM input circuit for PFC is that no feedforward control loop is required. This is also the main advantage over a CCM PFC circuit, in which multiloop control strategy is essential. However, the input inductor operating in DCM...
cannot hold the excessive input energy because it must release all its stored energy before the end of each switching cycle. As a result, a bulky capacitor is used to balance the instantaneous power between the input and output. In addition, in DCM, the input current is normally a train of triangle pulses with nearly constant duty ratio. In this case, an input filter is necessary for smoothing the pulsating input current.

19.5.1 Power Factor Correction Capabilities of the Basic Converter Topologies in DCM

The DCM input circuit can be one of the basic dc–dc converter topologies. However, when they are applied to the rectified line voltage, they may draw different shapes of average line current. In order to examine the PFC capabilities of the basic converters, we first investigate their input characteristics. Because the input currents of these converters are discrete when they are operating in DCM, only averaged input currents are considered. Since switching frequency is much higher than the line frequency, let’s assume the line voltage is constant in a certain range, the relationship between input current and line voltage is nearly constant and the variation in duty ratio is slight. Therefore, constant duty ratio is considered in deriving the input characteristics.

**A. Buck Converter**

The basic buck converter topology and its input current waveform when operating in DCM are shown in Figs. 19.26a and b, respectively. It can be shown that the average input current in one switching cycle is given by

\[ i_{\text{avg}}(t) = \frac{1}{T_s} \left[ \frac{1}{2} DT_s i_V(t) - \frac{V_o}{L} DT_s \right] \]

where, \( D \) is the duty ratio and \( T_s \) is the switching period. Since switching frequency is much higher than the line frequency, let’s assume the line voltage is constant in a certain range, the relationship between \( i_V(t) \) and \( i_{\text{avg}}(t) \) is nearly linear. When the boost converter is connected to the line, it will draw almost sinusoidal average input current from the line, as shown in Fig. 19.27c. As one might notice from Eq. (19.25) that the main reason to cause the non-linearity is the existence of \( D_t \). Ideally, if \( D_t = 0 \), the input \( I–V \) characteristic will be a linear one.

Because of the above reasons, boost converter is comparably superior to most of the other converters when applied to do PFC. However, it should be noted that boost converter can operate properly only when the output voltage is higher and III. It should be noted that these straight lines do not go through the origin. When the rectified line voltage \( V_i(t) \) is less than the output voltage \( V_o \), negative input current would occur. This is not allowed because the bridge rectifier will block the negative current. As a result, the input current is zero near the zero crossing of the line voltage, as shown in Fig. 19.26c. Actually, the input current is distorted simply because the buck converter can work only under the condition when the input voltage is larger than the output voltage. Therefore, the basic buck converter is not a good candidate for DCM input PFC.

**B. Boost Converter**

The basic boost converter and its input current waveform are shown in Figs. 19.27a and b, respectively. The input \( I–V \) characteristic can be found as follows

\[ i_{\text{avg}}(t) = \frac{1}{T_s} \left[ \frac{1}{2} \left( D + D_t \right) \frac{V_i(t)}{L} DT_s \right] \]

\[ = \frac{D^2 T_s}{2L} V_i(t) - \frac{D^2 T_s}{2L} V_o \]

Figure 19.26c shows that the input voltage–input current \( I–V \) characteristic consists of two straight lines in quadrants I and III. It should be noted that these straight lines do not go through the origin. When the rectified line voltage \( V_i(t) \) is less than the output voltage \( V_o \), negative input current would occur. This is not allowed because the bridge rectifier will block the negative current. As a result, the input current is zero near the zero crossing of the line voltage, as shown in Fig. 19.26c. Actually, the input current is distorted simply because the buck converter can work only under the condition when the input voltage is larger than the output voltage. Therefore, the basic buck converter is not a good candidate for DCM input PFC.

**TABLE 19.1 Comparison of CCM shaping techniques**

<table>
<thead>
<tr>
<th>Input ripple switching frequency</th>
<th>Average current</th>
<th>VF peak-current</th>
<th>CF peak-current</th>
<th>Hysteresis</th>
<th>Charge</th>
<th>Non-linear carrier voltage</th>
<th>Capacitor voltage</th>
<th>Inductor voltage</th>
</tr>
</thead>
<tbody>
<tr>
<td>Low</td>
<td>High</td>
<td>High</td>
<td>High</td>
<td>Low</td>
<td>Low</td>
<td>Low</td>
<td>Low</td>
<td>Low</td>
</tr>
<tr>
<td>Variable</td>
<td>Variable</td>
<td>Variable</td>
<td>Variable</td>
<td>Constant</td>
<td>Low</td>
<td>Variable</td>
<td>Variable</td>
<td>Variable</td>
</tr>
<tr>
<td>Slow</td>
<td>Slow</td>
<td>Slow</td>
<td>Fast</td>
<td>Fast</td>
<td>Fast</td>
<td>Fast</td>
<td>Fast</td>
<td>Fast</td>
</tr>
</tbody>
</table>

**Input signal sensed for inner loop E/A**

- Yes
- No

<table>
<thead>
<tr>
<th>Inner loop E/A Multiplier</th>
<th>Input current &amp; input voltage</th>
<th>Input (or switch) current &amp; input voltage</th>
<th>Input (or switch) current &amp; input voltage</th>
<th>Input (or switch) current &amp; input voltage</th>
<th>Input voltage &amp; capacitor voltage</th>
<th>Input voltage &amp; inductor voltage</th>
</tr>
</thead>
<tbody>
<tr>
<td>Yes</td>
<td>Yes</td>
<td>Yes</td>
<td>Yes</td>
<td>Yes</td>
<td>Yes</td>
<td>Yes</td>
</tr>
<tr>
<td>No</td>
<td>No</td>
<td>No</td>
<td>No</td>
<td>No</td>
<td>No</td>
<td>No</td>
</tr>
</tbody>
</table>
than its input voltage. When low voltage output is needed, a stepdown dc–dc converter must be cascaded.

C. Buck–Boost Converter

Figure 19.28a shows a basic buck–boost converter. The averaged input current of this converter can be found according to its input current waveform, shown in Fig. 19.28b.

\[ i_{\text{avg}}(t) = \frac{D^2 T_s}{2L} v(t) \]  \hspace{1cm} (19.26)

Equation (19.26) gives a perfect linear relationship between \( i_{\text{avg}}(t) \) and \( v(t) \), which proves that a buck–boost has an excellent automatic PFC property. This is because the input current of buck–boost converter does not related to the discharging period \( D_1 \). Its input \( I–V \) characteristics and input voltage and current waveforms are shown in Fig. 19.28c. Furthermore, because the output voltage of buck–boost converter can be either larger or smaller than the input voltage, it demonstrates strong availability for DCM input technique to achieve PFC. So, theoretically buck–boost converter is a

**FIGURE 19.26** Input \( I–V \) characteristic of basic buck converter operating in DCM: (a) buck converter; (b) input current; and (c) input \( I–V \) characteristic.

**FIGURE 19.27** Input \( I–V \) characteristic of basic boost converter operating in DCM: (a) boost converter; (b) input current; and (c) input \( I–V \) characteristic.
perfect candidate. Unfortunately, this topology has two limitations: (1) the polarity of its output voltage is reversed, i.e. the input voltage and the output voltage don’t have a common ground; and (2) it needs floating drive for the power switch. The first limitation circumscribes this circuit into a very narrow scope of applications. As a result, it is not widely used.

**D. Flyback Converter**

Flyback converter is an isolated converter whose topology and input current waveform are shown in Figs. 19.29a and b, respectively. The input voltage–input current relationship is similar to that of buck–boost converter

\[
i_{1,\text{avg}}(t) = \frac{D^2 T_s}{2 L_m} v_3(t) \tag{19.27}
\]

where, \(L_m\) is the magnetizing inductance of the output transformer.

Therefore, it has the same input \(I–V\) characteristic, and hence the same input voltage and input current waveforms as those the buck–boost converter has, shown in Fig. 19.29c. Comparing with buck–boost converter, flyback converter has all the advantages of the buck–boost converter. What’s more, input–output isolation can be provided by flyback converter. These advantages make flyback converter well suitable for PFC with DCM input technique. Comparing with boost converter, the flyback converter has better PFC and the output voltage can be either higher or lower than the input voltage. However, due to the use of power transformer, the flyback converter has high \(di/dt\) noise, lower efficiency, and lower density (larger size and heavier weight).

**E. Forward Converter**

The circuit shown in Fig. 19.30 is a forward converter. In order to avoid transformer saturation, it is well-known that forward converter needs the 3rd winding to demagnetize (reset) the transformer. When a forward converter is connected to the rectified line voltage, the demagnetizing current through the 3rd winding is blocked by the rectifier diodes.
Therefore, forward converter is not available for PFC purpose unless a certain circuit modification is applied.

F. Cuk Converter and Sepic Converter

It can be shown that Cuk converter and Sepic converter given in Figs. 19.31a and b, respectively, have the same input $I-V$ characteristic. Each of these converter topologies has two inductors, with one located at its input and the other at its output. Let’s consider the case when the input inductor operates in DCM while the output inductor operates in CCM. In this case, the capacitor $C_1$ can be designed with large value to balance the instantaneous input/output power, resulting in high PF in the input and low second harmonic ripple in the output voltage. To investigate the input characteristic of these converters, let’s take the Cuk converter as an example. One should note that the results from the Cuk converter are also suitable for Sepic converter.

For the Cuk converter shown in Fig. 19.31a, the waveforms for input inductor current (the same as the input current), output inductor current, and the voltage across the output inductor are depicted in Fig. 19.31c. Assume that the capacitor $C_1$ is large enough to be considered as a voltage source $V_c$ in steady state, employing volt-second equilibrium principle on $L_2$, we obtain

$$V_C = \frac{1}{D} V_o$$

(19.28)

The input inductor current reset time ratio $D_1$ is given by

$$D_1 = \frac{D_2}{V_o - Dv_1(t)}$$

(19.29)

Therefore the averaged input current can be found as

$$i_{avg}(t) = \frac{1}{T_s} \left[ \frac{1}{2} \left( D + D_1 \right) T_s \frac{v_1(t)}{L} DT_s \right]$$

(19.30)

$$= \frac{D_2 T_s}{2L} \frac{v_1(t)}{V_o - Dv_1(t)}$$

It can be seen that Eq. (19.30) is very similar to Eq. (19.25) except that the denominator in the former equation is $(V_o - Dv_1(t))$ instead of $(V_o - v_1(t))$. This will lead to some improvement in that $I-V$ characteristic in Cuk converter. Referring to the $I-V$ characteristic shown in Fig. 19.27c, Cuk converter has a curve more close to a straight line. Such improvement, however, is achieved at the expense of using more circuit components. It can be proved that the same results can be obtained by the Sepic converter.

G. Zeta Converter

Figure 19.32a gives a Zeta converter connected to the line. In DCM operation, the key waveforms are illustrated in Fig. 19.32b, where we presume the capacitor being equivalent to a voltage source $V_c$. As we can see that the converter input current waveform is exactly the same as that drawn by a
buck–boost converter. Thus, the average input current for the Zeta converter is identical to that for the buck–boost converter, which is given by Eq. (19.26). As a result, the Zeta converter has as good automatic PFC capability as the buck–boost converter. The improvement achieved here is the non-inverted output voltage. However, like the buck converter, floating drive is required for the power switch.

Based on the above discussion, we may conclude that all the eight basic converters except forward converter have good inherent PFC capability and are available for DCM PFC usage. Among them, boost converter and flyback converter are especially suitable for single-stage PFC scheme because they have minimum component count and grounded switch drive, and their power switches are easy to be shared with the output dc–dc converter. Hence, these two converters are most preferable by the designers for PFC purpose. The other converters could also be used to perform certain function such as circuit protection and small output voltage ripple. The characteristics of the eight basic converter topologies are summarized in Table 19.2.

19.5.2 AC–DC Power Supply with DCM Input Technique

In two-stage PFC power supply, the DCM converter is connected in front of the ac line to achieve high input PF and provide a roughly regulated dc bus voltage, as shown in Fig. 19.33. This stage is also known as “pre-regulator.” The duty ratio of the pre-regulator should be maintained relatively stable so that high PF is ensured. To stabilize the dc bus voltage, a bank capacitor is used at the output of the pre-regulator. The second stage, followed by the pre-regulator, is a dc–dc converter, called post-regulator, with its output voltage being tightly controlled. This stage can operate either in DCM or in CCM. However, CCM is normally preferred to reduce the output voltage ripple.

DCM input technique has been widely used in one-stage PFC circuit configurations. Using a basic converter
TABLE 19.2  Comparison of basic converter topologies operating for DCM input technique

<table>
<thead>
<tr>
<th>Line current waveform</th>
<th>Buck</th>
<th>Boost</th>
<th>Buck–boost</th>
<th>Flyback</th>
<th>Forward*</th>
<th>Cuk and sepic</th>
<th>Zeta</th>
</tr>
</thead>
<tbody>
<tr>
<td>Switch drive</td>
<td>Floating</td>
<td>High</td>
<td>Floating</td>
<td>Grounded</td>
<td>Grounded</td>
<td>Floating</td>
<td>Floating</td>
</tr>
<tr>
<td>Peak input current</td>
<td>High</td>
<td>Lower</td>
<td>High</td>
<td>Yes</td>
<td>Lower</td>
<td>-</td>
<td>-</td>
</tr>
<tr>
<td>Inrush and overload protection</td>
<td>Yes</td>
<td>No</td>
<td>Yes</td>
<td>-</td>
<td>Yes</td>
<td>Yes</td>
<td>Yes</td>
</tr>
<tr>
<td>Inrush and overload protection</td>
<td>-</td>
<td></td>
<td>-</td>
<td>-</td>
<td>-</td>
<td>-</td>
<td></td>
</tr>
<tr>
<td>Output voltage</td>
<td>$V_o &lt; V_{L,min}$</td>
<td>$V_o &gt; V_{L,min}$</td>
<td>Inverted</td>
<td>$V_o &lt; V_{L,min}$ or $V_o &gt; V_{L,min}$</td>
<td>$V_o &lt; V_{L,min}$ or $V_o &gt; V_{L,min}$</td>
<td>$V_o &lt; V_{L,min}$ or $V_o &gt; V_{L,min}$</td>
<td></td>
</tr>
</tbody>
</table>

*The standard forward converter is not recommended as a PF corrector since the rectifier at the input will block the demagnetizing current through the tertiary winding.

(usually boost or flyback converter) operating in DCM, combining it with another isolation converter can form a one-stage PFC circuit. A storage capacitor is generally required to hold the dc bus voltage in these combinations. Unlike the two-stage PFC circuit, in which the bus voltage is controlled, the single-stage PFC converter has only one feedback loop from the output. The input circuit and the output circuit must share the same control signal. In [39–41] a number of combinations have been studied. Figures 19.34 and 19.35 show a few examples of successful combinations. Since the input circuit and the output circuit are in a single stage, it is possible for them to share the same power switch. Thus it results in single-stage single-switch PFC (S4-PFC) circuit, as shown in Fig. 19.35 [39, 42, 43].

Due to the simplicity and low cost, DCM boost converter is most commonly used for unity PF operation. The main drawback of using boost converter is that it shows considerable distortion of the average line current owing to the slow discharging of the inductor after the switch is turned off.

The output dc–dc converter can operate either in DCM or in CCM if small output ripple is desired. If the output circuit operates in CCM, there exists a power unbalance in S4-PFC converter when the load changes. Because the duty ratio is only sensitive to the output voltage in CCM operation, when the output power (output current) decreases, the duty ratio will keep unchanged. As both the input and the output circuit share the power switch, the input circuit will draw an unchanged power from the ac source. As a result, the input power is higher than the output power. The difference between the input power and the output power has to be stored in the storage capacitor, and hence increase in the dc bus voltage occurs. With the dc bus voltage's rising, the duty ratio decreases. This process will be finished until a new power balance is achieved at the penalty of increased voltage stress, resulting in high conduction losses in circuit components. Particularly, the high bus voltage causes difficulties in developing S4-converter for universal input (input line voltage rms value from ac 90 to 260 V) application.

Recent research on solving this problem can be found in [44–52]. The circuit in [44] uses two bulk capacitors that share the dc bus voltage change, shown in Fig. 19.36a. As a result, lower voltage is present at each of the capacitor. Reference [45] proposed a modified boost–forward PFC converter, in which a negative current feedback is introduced to the input circuit by the coupled windings of forward transformer, shown in Fig. 19.36b. In [46] a series resonant circuit called charge pump circuit is introduced into S4-PFC circuit, shown in Fig. 19.36c. As the load decrease, the charge pump circuit can suppress the dc bus voltage automatically.
19.5.3 Other PFC Techniques

Extensive research in PFC continues to yield countless new techniques [15, 53–63]. The research topics are mainly focused on improvements of the PFC circuit performances such as fast performances, high efficiency, low cost, small input current distortion, and output ripple. The classification of PFC techniques presented here can only cover those methods that are frequently documented in the open literature. There are still many PFC methods which do not fall into the specified categories. The following are some examples:

- **Second-harmonic-injected method** [56]: In DCM input technique, even the converter operates at constant duty ratio, current distortion still exists. The basic idea of second-harmonic-injected method is compensating the duty ratio by injecting a certain amount of second harmonic into the duty ratio to modify the input I–V characteristic of the input converter. However, the output voltage may be affected by the modified duty ratio.

- **Interleaved method** [57]: An interleaved PFC circuit composed of several input converters in parallel. The peak input current of these converters follow the line voltage and are interleaved. A sinusoidal total line current is obtained by superimposing all the input current of the converters. The advantage of this method is that the converter input current can be easily smoothed by input EMI filter.

- **Waveform synthesis method** [58]: This method combines passive and active PFC techniques. Since the rectifier in the passive inductive-input PF corrector has a limited
conduction angle, the input current is a single pulse around the peak of the line voltage, whereas the boost converter draws a non-zero current around the zero-cross of the line voltage. By controlling the operation mode of the active switch (enable and disable the boost converter at certain line voltage), the waveforms of active and passive PFC circuits are tailored to extend the conduction angle of the rectifier. The resulting current waveform has a PF greater than 0.9 and a THD lower than 20%.

19.6 Summary

To reduce losses, and decrease weight and size associated with converting ac power to dc power in linear power supply, switch mode power supplies (SMPSs) were introduced. The high non-linearity of this kind of power electronic systems handicaps itself by providing the utility power system with low power factor (PF) and high total harmonic distortion (THD). These unwanted harmonics are commonly corrected by incorporating power factor correction (PFC) technique into the SMPS. This chapter gives a technical review of current research in high frequency PFC, including the definition of PF and THD, configuration of PFC circuit, DCM input technique, and CCM shaping technique. The common issue of these techniques is to properly process the power flow so that the constant power dissipation at the output is reflected into ac power dissipation with two times the line frequency. Technically, PFC techniques encounter the following tradeoffs:

(a) Simplicity and accuracy: Single-stage PFC circuit has simple topology and simple control circuit, but has less control accuracy while two-stage PFC circuit has the contrary performance;

(b) Control simplicity and power handling capability: DCM input technique requires no input current control, but has less power handling capability while CCM has multiloop control and has more power handling capability;

(c) Switching frequency and conversion efficiency: To reduce weight and size of the PFC converter, higher
switching frequency is desired. However, the associated switching losses result in decrease in conversion efficiency.

(d) Frequency response and bandwidth: To have good dynamic response, wider bandwidth is desired, however to achieve high PF bulk storage capacitor and output capacitor has to be used.

In the past decades, research in PFC techniques has led to the development of more efficient circuits and control strategies in order to optimize the design without compromising the above tradeoffs. Moreover, since the growth in power electronics strongly relies on the development of semiconductor devices, the recent advent of higher rating power devices, it is believed that the switching mode PF correctors will completely replace the existing passive reactive compensators in power system. In the distributed power system (DPS) where small size and high efficiency are of extreme importance, a new soft-switching technique has been used in designing PFC circuits. With the ever increasing market demanding for ultra-fast computer, the need for low output voltage (typically less than 1 V) with high output currents and high efficiency converters has never been greater. Research efforts in developing high frequency high efficiency PFC circuits will continue to grow.

Acknowledgment

I would like to thank my doctoral students Guangyong Zhu, Shiguo Luo, and Wenkai Wu for their valuable contribution to the area of power factor correction.

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